

**FRED**  
**Ultrafast Soft Recovery Diode Module**  
**200A x 2 / 400V**

## FEATURES

- Very low  $Q_{rr}$  and  $t_{rr}$
- Lead (Pb)-free
- Designed and qualified for industrial level
- Reduced RFI and EMI
- Reduced snubbing
- Planar FRED Chip
- Epoxy molding structure
- 175°C Junction temperature

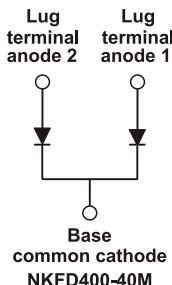
## DESCRIPTION

FRED diodes are optimized to reduce losses and EMI/RFI in high frequency power conditioning systems.

An extensive characterization of the recovery behavior for different values of current, temperature and  $dI/dt$  simplifies the calculations of losses in the operating conditions. The softness of the recovery eliminates the need for a snubber in most applications.



TO-244M (non-insulated)



## TYPICAL APPLICATIONS

- Power converters
- Motor drives
- Welders
- Switching power supplies
- Uninterruptible power supply (UPS)
- Power factor correction (PFC) circuit
- Inverter
- Choppers
- Battery chargers

## PRODUCT SUMMARY

$I_{F(AV)}$	400A
$V_R$	400V
$I_{F(DC)} \text{ at } T_C$	280A at 76 °C

## ABSOLUTE MAXIMUM RATINGS

PARAMETER	SYMBOL	TEST CONDITIONS	MAX.	UNIT
Cathode to anode voltage	$V_R$		400	V
Average forward current	$I_{F(AV)}$	$T_C = 25^\circ\text{C}$ , per leg	400	A
		$T_C = 107^\circ\text{C}$ per device	400	
		per leg	200	
Single pulse forward current	$I_{FSM}$	Limited by junction temperature, per leg	2000	
Non-repetitive avalanche energy	$E_{AS}$	$L = 100 \mu\text{H}$ , duty cycle limited by maximum $T_J$	1.4	
Maximum power dissipation	$P_D$	$T_C = 25^\circ\text{C}$	700	W
		$T_C = 100^\circ\text{C}$	310	
Operating junction and storage temperature range	$T_J, T_{Stg}$		- 55 to 175	°C

**ELECTRICAL SPECIFICATIONS ( $T_J = 25^\circ\text{C}$  unless otherwise specified)**

PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Cathode to anode breakdown voltage	$V_{BR}$	$I_R = 100 \mu\text{A}$	400	-	-	
Maximum forward voltage	$V_{FM}$	$I_F = 200 \text{ A}$	-	1.10	1.25	V
		$I_F = 400 \text{ A}$	-	1.28	1.45	
		$I_F = 200 \text{ A}, T_J = 125^\circ\text{C}$	-	0.95	1.10	
Maximum reverse leakage current per leg	$I_{RM}$	$T_J = 125^\circ\text{C}, V_R = 400\text{V}$	-	2.0	10	mA
		$T_J = 25^\circ\text{C}, V_R = 400\text{V}$	-	2.0	10	$\mu\text{A}$
Junction capacitance	$C_T$	$V_R = 200\text{V}$	-	460	620	pF
Series inductance	$L_S$	From top of terminal hole to mounting plane	-	5.0	-	nH

**DYNAMIC RECOVERY CHARACTERISTICS PER LEG ( $T_J = 25^\circ\text{C}$  unless otherwise specified)**

PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Reverse recovery time	$t_{rr}$	$I_F = 0.5\text{A}, I_R = 1.0\text{A}, I_{RR} = 0.25\text{A}$	-	110	120	ns
		$I_F = 1.0\text{A}, dI_F/dt=200\text{A}/\mu\text{s}, V_R = 30\text{V}$	-	75	-	
		$T_J = 25^\circ\text{C}$	-	95	-	
		$T_J = 125^\circ\text{C}$	-	300	-	
Peak recovery current	$I_{RRM}$	$T_J = 25^\circ\text{C}$	-	9.7	26	A
		$T_J = 125^\circ\text{C}$	-	20	34	
Reverse recovery charge	$Q_{rr}$	$T_J = 25^\circ\text{C}$	-	500	1400	nC
		$T_J = 125^\circ\text{C}$	-	2900	7700	
Peak rate of recovery current	$dI_{(rec)M}/dt$	$T_J = 25^\circ\text{C}$	-	280	-	$\text{A}/\mu\text{s}$
		$T_J = 125^\circ\text{C}$	-	260	-	

**THERMAL AND MECHANICAL SPECIFICATIONS**

PARAMETER	SYMBOL	MIN.	TYP.	MAX.	UNIT
Maximum junction and storage temperature range	$T_J, T_{stg}$	-55	-	175	$^\circ\text{C}$
Thermal resistance, junction to case per leg	$R_{thJC}$	-	-	0.15	$^\circ\text{C}/\text{W}$
Thermal resistance, junction to case per module		-	-	0.075	
Typical thermal resistance, case to heatsink	$R_{thCS}$	-	0.10	-	
Weight	TO-244M (non-insulated)	-	80 (2.82)	-	g (oz.)
Mounting torque <sup>(1)</sup>		30 (3.4)	-	40 (4.6)	$\text{lbf}\cdot\text{in}$ (N·m)
Mounting torque center hole		12 (1.4)	-	18 (2.1)	
Terminal torque		30 (3.4)	-	40 (4.6)	
Vertical pull		-	-	80	$\text{lbf}\cdot\text{in}$
2" lever pull		-	-	35	

Note

(1)Mounting surface must be smooth, flat, free of burrs or other protrusions. Apply a thin even film or thermal grease to mounting surface.

Gradually tighten each mounting bolt in 5 to 10 lbf. in steps until desired or maximum torque limits are reached

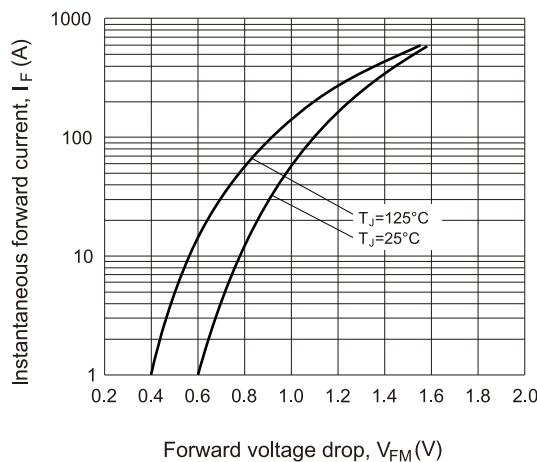
### Ordering Information Table

Device code

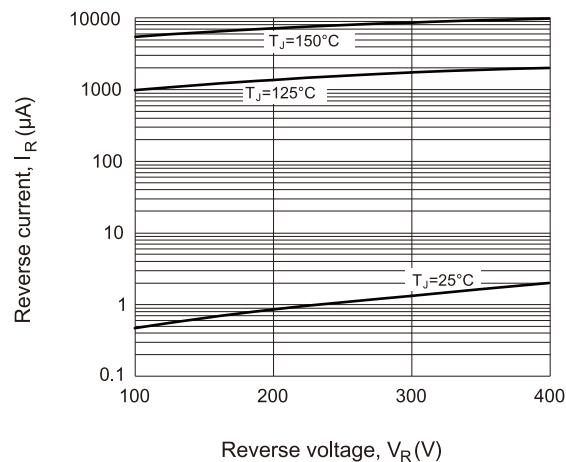
<b>NK</b>	<b>F</b>	<b>D</b>	<b>400</b>	—	<b>40</b>	<b>M</b>
(1)	(2)	(3)	(4)		(5)	(6)

- [1] - Nell's power module
- [2] - F for Ultrafast soft recovery diode
- [3] - D for Dual Diodes, TO-244 Package
- [4] - Maximum average forward current, A
- [5] - Voltage rating (40 = 400V)
- [6] - M for Molding structure

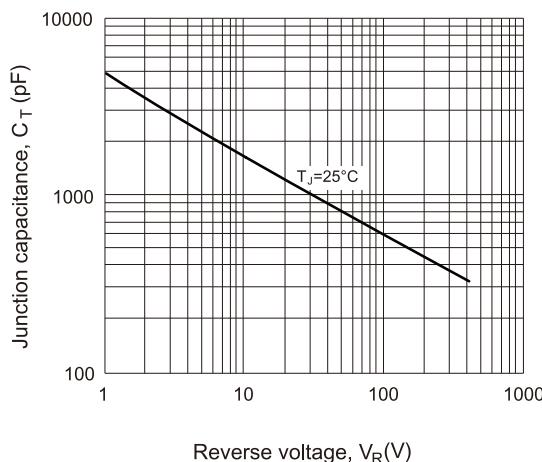
**Fig.1 Maximum forward voltage drop vs. Instantaneous forward current (per leg)**



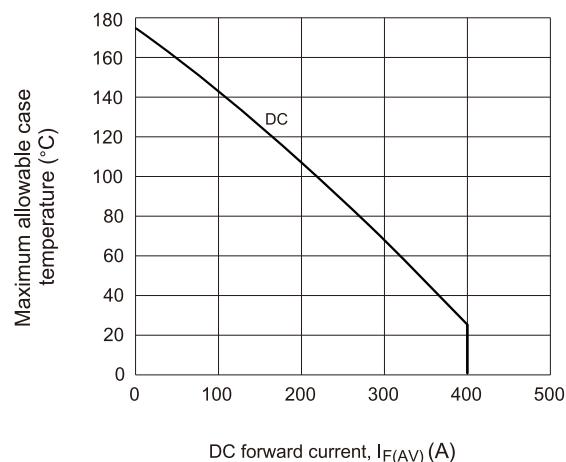
**Fig.2 Typical reverse current vs. reverse voltage (per leg)**



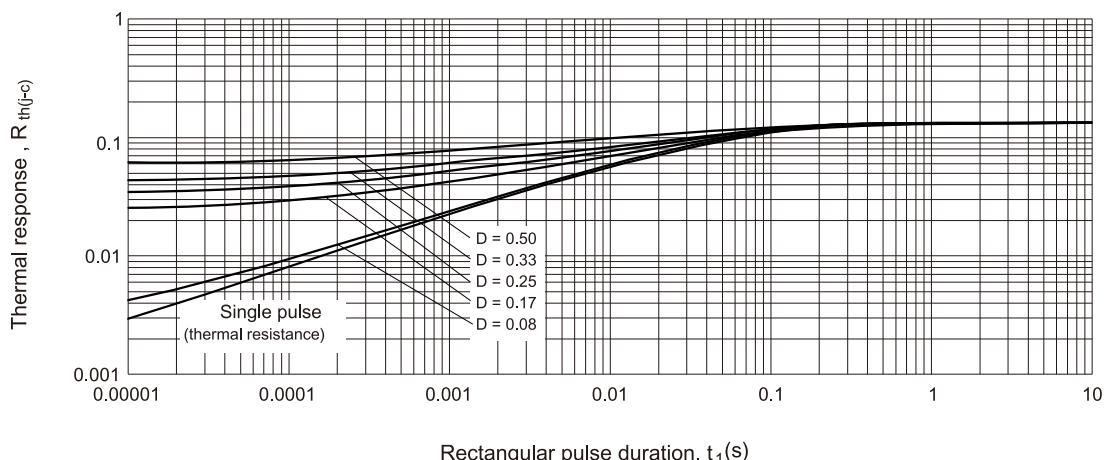
**Fig.3 Typical junction capacitance vs. reverse voltage (per leg)**



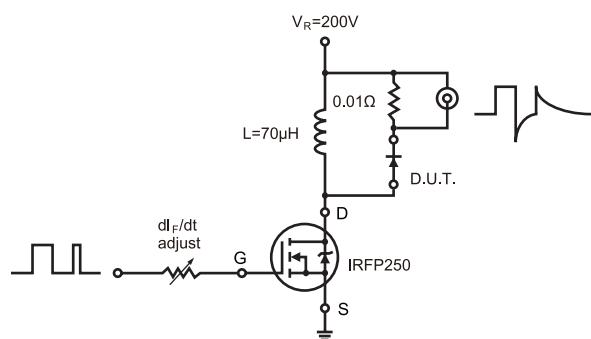
**Fig.4 Maximum allowable case temperature vs. DC forward current (per leg)**



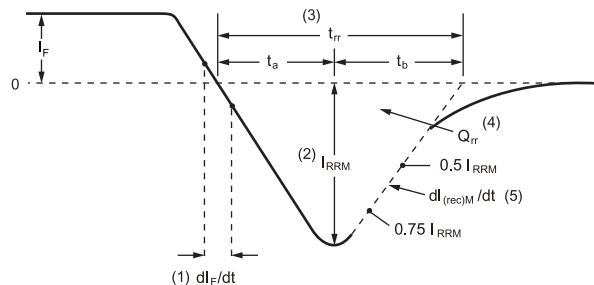
**Fig.5 Maximum thermal impedance  $R_{th(j-c)}$  characteristics  
(per leg, for TO-244M non-insulated)**



**Fig.6 Reverse recovery parameter test circuit**



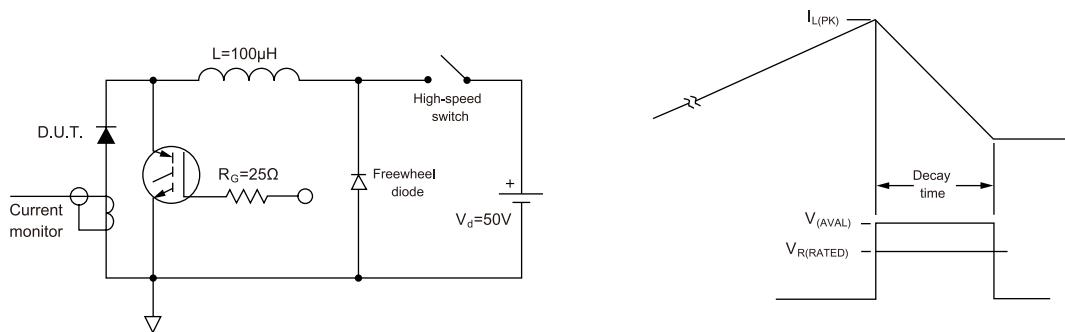
**Fig.7 Reverse recovery waveform and definitions**



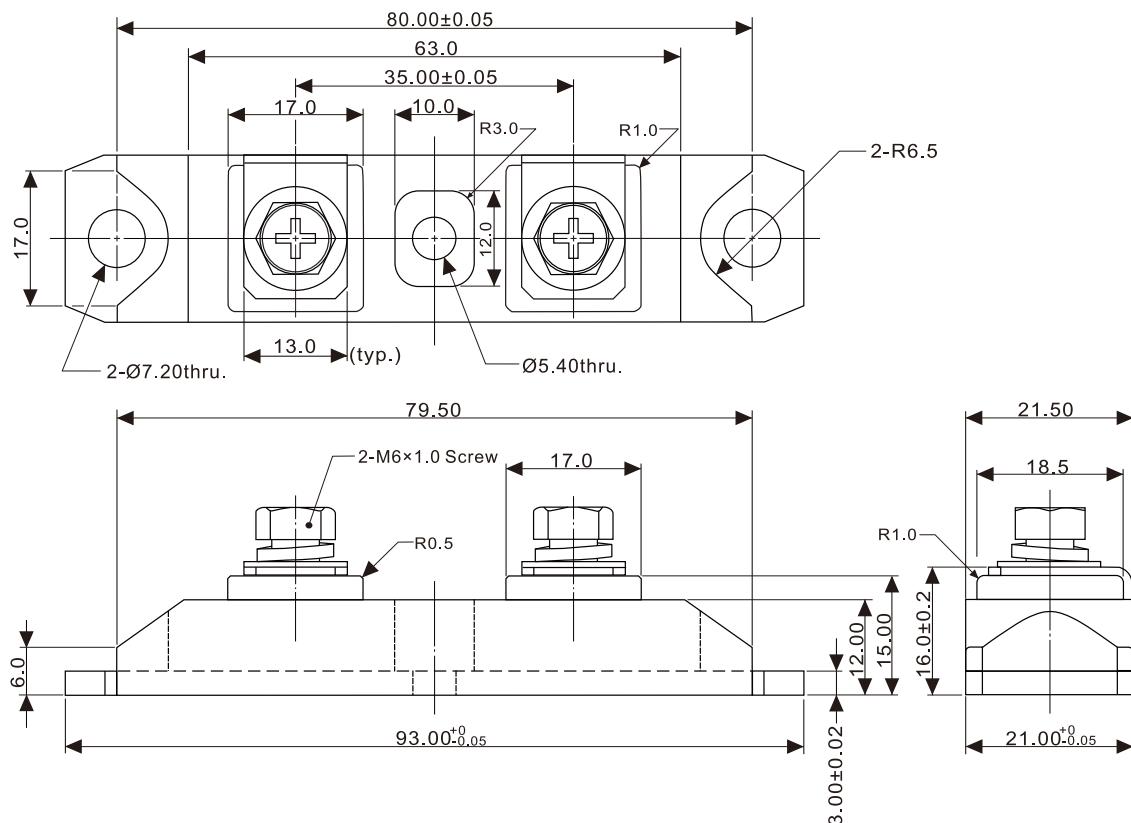
- (1)  $dI_F/dt$  - rate of change of current through zero crossing  
(2)  $I_{RRM}$  - peak reverse recovery current  
(3)  $t_{rr}$  - reverse recovery time measured from zero crossing point of negative going  $I_F$  to point where a line passing through  $0.75 I_{RRM}$  and  $0.50 I_{RRM}$  extrapolated to zero current.  
(4)  $Q_{rr}$  - area under curve defined by  $t_{rr}$  and  $I_{RRM}$   

$$Q_{rr} = \frac{t_{rr}}{2} \times I_{RRM}$$
  
(5)  $dI_{(rec)M}/dt$  - peak rate of change of current during  $t_b$  portion of  $t_{rr}$

**Fig.8 Avalanche test circuit and waveforms**



## TO-244M (Non-Insulated)



All dimensions in millimeters